

# HSF

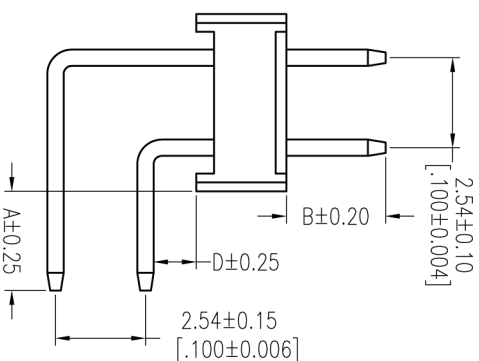
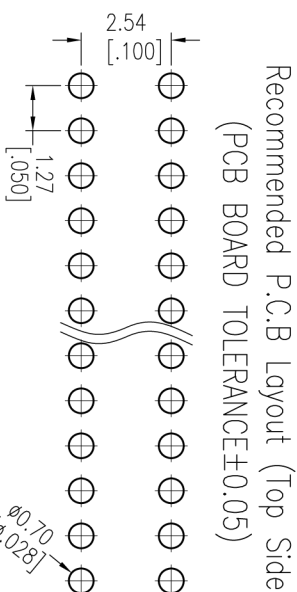
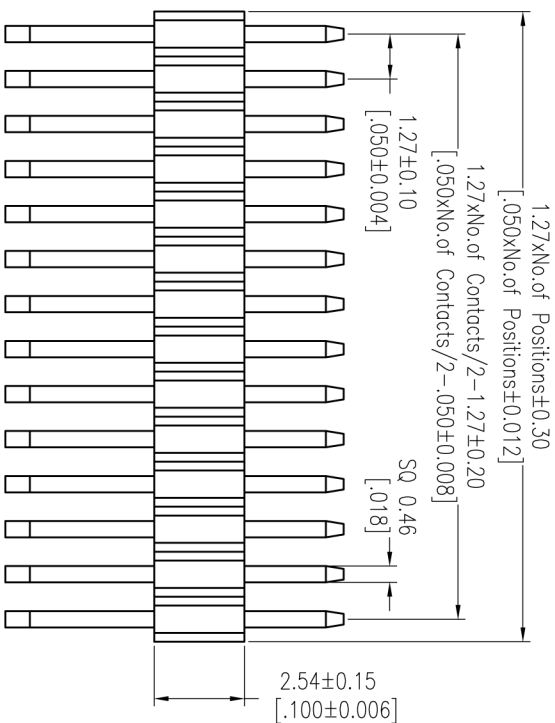
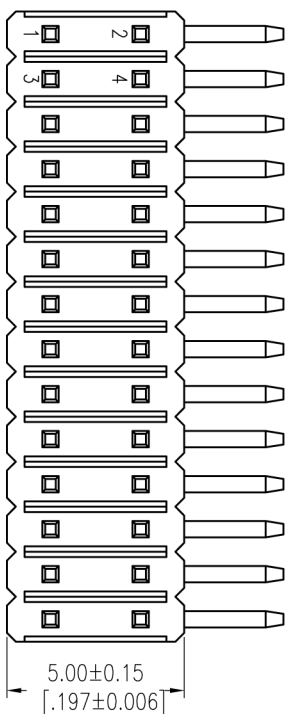
NOTES:  
 Rated Current:1.0AMP.  
 Contact Resistance:20mΩ Max.  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ Min.  
 Operation Temperature:-40℃ to +105℃  
 Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:PA9T+30%G.F UL94V-0 BK

## Ordering Information

1425-12 XX XX R XXX X 1

No. of Pins Contact Plating Pin Length(short) Packing  
 Per Row:02-50 G0=Gold Flash L=A+B+D+3.8 A=Tray  
 G3=10u"Gold Standard:106=10.6 T=Tube  
 G4=15u"Gold 140=14.0  
 G5=30u"Gold  
 S0=Gold Flash/Tin  
 S3=10u"Gold/Tin  
 S4=15u"Gold/Tin  
 S5=30u"Gold/Tin

Item	Pin Length	A	D	B	Mating
Standard	10.60	2.80	1.20	2.80	2446
Alternate	14.00	3.00	1.20	6.00	2485



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A0	2012/04/06	NEW	-----	XX ±0.40	<i>William Chen</i>	2012.04.06	mm	A4	1425-12XXXXXXXXXX
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	XX ±0.25	CHECK	DATE	UNIT	mm	TITLE:
				X.XXX ±0.15	APPROVE	DATE	SIZE	A4	PHI. 27*2.54 DUAL ROW
				Angle ± 3'		DATE	SHEET	1/1	90° CONCAVE BENDING H=2.54
				DIM TOL		DATE	PROJ.		Customer NO.

**hf** 上海回峰电子科技有限公司  
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